

# Certificate

Management system as per  
**ISO 45001: 2018**



The Certification Body TÜV NORD CERT GmbH hereby confirms as a result of the audit, assessment and certification decision according to ISO/IEC 17021-1:2015, that the organization

**ChipMOS TECHNOLOGIES INC.**

**No. 1, Yanfa 1st Rd., Hsinchu Science Park,  
Hsinchu County, Taiwan (R.O.C.)**



**with the locations according to the annex**

operates a management system in accordance with the requirements of ISO 45001 : 2018 and will be assessed for conformity within the 3 year term of validity of the certificate.

Scope

**Manufacturing of IC Package and Assembly  
Bumping and Wafer Sort Production for Semiconductors**

Certificate Registration No. 44 126 20 82 0164  
Audit Report No. 2.5-5978/2025

Valid from 2025-07-09  
Valid until 2028-07-08  
Initial certification 2010-07-09



Visit our database to  
verify the validity of  
this certificate.

Taipei, 2025-06-17

*Lie-Teng Chang*  
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Certification Body at TÜV NORD CERT GmbH.

TÜV NORD CERT GmbH  
Am TÜV 1, 45307 Essen  
tuev-nord-cert.de



# Annex

to Certificate Registration No. 44 126 20 82 0164  
**ISO 45001: 2018**

**ChipMOS TECHNOLOGIES INC.**  
**No. 1, Yanfa 1st Rd.,**  
**Hsinchu Science Park,**  
**Hsinchu County, Taiwan (R.O.C.)**



| Certificate Registration No. | Location                                                                                                                 | Scope                                                       |
|------------------------------|--------------------------------------------------------------------------------------------------------------------------|-------------------------------------------------------------|
| 44 126 20 82 0164-001        | ChipMOS TECHNOLOGIES INC.<br><br>No. 1, Yanfa 1st Rd., Hsinchu Science Park, Hsinchu County, Taiwan (R.O.C.)             | Testing, Warehousing, Backend Production for Semiconductors |
| 44 126 20 82 0164-002        | ChipMOS TECHNOLOGIES INC.<br><br>No. 3 & 5, Nanke 7th Rd., Southern Taiwan Science Park, Tainan City, Taiwan, (R. O. C.) | Manufacturing of IC Package and Assembly                    |
| 44 126 20 82 0164-003        | ChipMOS TECHNOLOGIES INC.<br><br>No. 37, Xintai Rd., Zhubei City, Hsinchu County, Taiwan, (R. O. C.)                     | Bumping and Wafer Sort Production for Semiconductors.       |

Taipei, 2025-06-17

Lie-Teng Chang

Certification Body at TÜV NORD CERT GmbH



# Annex

to Certificate Registration No. 44 126 20 82 0164  
**ISO 45001: 2018**

**ChipMOS TECHNOLOGIES INC.**  
**No. 1, Yanfa 1st Rd.,**  
**Hsinchu Science Park,**  
**Hsinchu County, Taiwan (R.O.C.)**



| Certificate Registration No. | Location                                                                                                | Scope                                                          |
|------------------------------|---------------------------------------------------------------------------------------------------------|----------------------------------------------------------------|
| 44 126 20 82 0164-004        | ChipMOS TECHNOLOGIES INC.<br><br>No. 4, Rende Rd, Hukou Township,<br>Hsinchu County, Taiwan, (R.O.C.)   | Testing, Warehousing, Backend<br>Production for Semiconductors |
| 44 126 20 82 0164-005        | ChipMOS TECHNOLOGIES INC.<br><br>No. 112, Zhonghe St., Zhubei City,<br>Hsinchu County, Taiwan, (R.O.C.) | Testing, Warehousing, Backend<br>Production for Semiconductors |

End of the List

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Taipei, 2025-06-17

Lie-Teng Chang

Certification Body at TÜV NORD CERT GmbH